

## PATENT ASSIGNMENT COVER SHEET

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 Stylesheet Version v1.2

EPAS ID: PAT2731085

SUBMISSION TYPE:	NEW ASSIGNMENT														
NATURE OF CONVEYANCE:	ASSIGNMENT														
CONVEYING PARTY DATA															
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>JI-HYUN PARK</td> <td>02/13/2014</td> </tr> <tr> <td>JUNG-HYUNG KIM</td> <td>02/13/2014</td> </tr> <tr> <td>BO-RAM NAMGOONG</td> <td>02/13/2014</td> </tr> <tr> <td>SANG-MI PARK</td> <td>02/13/2014</td> </tr> <tr> <td>SUNG-KWANG YANG</td> <td>02/13/2014</td> </tr> <tr> <td>BO-KUN CHOI</td> <td>02/13/2014</td> </tr> </tbody> </table>		Name	Execution Date	JI-HYUN PARK	02/13/2014	JUNG-HYUNG KIM	02/13/2014	BO-RAM NAMGOONG	02/13/2014	SANG-MI PARK	02/13/2014	SUNG-KWANG YANG	02/13/2014	BO-KUN CHOI	02/13/2014
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SANG-MI PARK	02/13/2014														
SUNG-KWANG YANG	02/13/2014														
BO-KUN CHOI	02/13/2014														
RECEIVING PARTY DATA															
Name:	SAMSUNG ELECTRONICS CO., LTD.														
Street Address:	129, SAMSUNG-RO, YEONGTONG-GU														
City:	SUWON-SI, GYEONGGI-DO														
State/Country:	KOREA, REPUBLIC OF														
PROPERTY NUMBERS Total: 1															
<table border="1"> <thead> <tr> <th>Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>14150337</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	14150337										
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Application Number:	14150337														
CORRESPONDENCE DATA															
Fax Number:															
Phone:	202-293-0804														
Email:	usdocketing@jeffersonip.com														
<i>Correspondence will be sent via US Mail when the email attempt is unsuccessful.</i>															
Correspondent Name:	JEFFERSON IP LAW, LLP														
Address Line 1:	1130 CONNECTICUT AVE., NW, SUITE 420														
Address Line 4:	WASHINGTON, DISTRICT OF COLUMBIA 20036														
ATTORNEY DOCKET NUMBER:	0202-0905														
NAME OF SUBMITTER:	JAMES J. LIVINGSTON														

Signature:	/James J. LIVINGSTON/
Date:	02/18/2014
Total Attachments: 4 source=0202-0905AssignmentAsFiled#page1.tif source=0202-0905AssignmentAsFiled#page2.tif source=0202-0905AssignmentAsFiled#page3.tif source=0202-0905AssignmentAsFiled#page4.tif	

# RECORDATION FORM COVER SHEET PATENTS ONLY

To the Director of the U.S. Patent and Trademark Office: Please record the attached documents or the new address(es) below.

**1. Name of conveying party(ies)**  
 1) Ji-Hyun PARK, 2) Jung-Hyung KIM, 3) Bo-Ram NAMGOONG,  
 4) Sang-Mi PARK, 5) Sung-Kwang YANG, and 6) Bo-Kun CHOI

Additional name(s) of conveying party(ies) attached?  Yes  No

**2. Name and address of receiving party(ies)**  
 Name: Samsung Electronics Co., Ltd.  
 Internal Address: \_\_\_\_\_  
 \_\_\_\_\_  
 Street Address: 129, Samsung-ro, Yeongtong-gu  
 \_\_\_\_\_  
 City: Suwon-si, Gyeonggi-do  
 State: \_\_\_\_\_  
 Country: Republic of Korea Zip: \_\_\_\_\_  
 Additional name(s) & address(es) attached?  Yes  No

**3. Nature of conveyance/Execution Date(s):**  
 Execution Date(s) February 13, 2014

Assignment  Merger  
 Security Agreement  Change of Name  
 Joint Research Agreement  
 Government Interest Assignment  
 Executive Order 9424, Confirmatory License  
 Other \_\_\_\_\_

**4. Application or patent number(s):**  This document is being filed together with a new application.

A. Patent Application No.(s)  
14/150,337

B. Patent No.(s)

Additional numbers attached?  Yes  No

**5. Name and address to whom correspondence concerning document should be mailed:**  
 Name: Jefferson IP Law, LLP  
 Internal Address: James J. Livingston  
 \_\_\_\_\_  
 Street Address: 1130 Connecticut Ave., NW, Suite 420  
 \_\_\_\_\_  
 City: Washington  
 State: DC Zip: 20036  
 Phone Number: 202-293-0804  
 Fax Number: 202-403-3587  
 Email Address: usdocketing@jeffersonip.com

**6. Total number of applications and patents involved:** One

**7. Total fee (37 CFR 1.21(h) & 3.41) \$** \_\_\_\_\_

Authorized to be charged by credit card  
 Authorized to be charged to deposit account  
 Enclosed  
 None required (government interest not affecting title)

**8. Payment Information**

a. Credit Card Last 4 Numbers \_\_\_\_\_  
 Expiration Date \_\_\_\_\_

b. Deposit Account Number \_\_\_\_\_  
 Authorized User Name \_\_\_\_\_

**9. Signature:** \_\_\_\_\_ /James J. LIVINGSTON/ Reg. #55,394 \_\_\_\_\_ February 18, 2014 \_\_\_\_\_  
 Signature Date

James J. Livingston \_\_\_\_\_  
 Name of Person Signing

Total number of pages including cover sheet, attachments, and documents: 4

**Assignment**

*WHEREAS*, the following inventors, namely 1) Ji-Hyun PARK, 2) Jung-Hyung KIM, 3) Bo-Ram NAMGOONG, 4) Sang-Mi PARK, 5) Sung-Kwang YANG, and 6) Bo-Kun CHOI, all, citizens of the Republic of Korea (hereinafter called "Assignors"), having made or discovered certain new, useful and non-obvious improvements in an invention having a working title of:

**METHOD AND APPARATUS FOR DISPLAYING INFORMATION ABOUT  
WIRELESS CHARGING PAD IN ELECTRONIC DEVICE,**

for which a United States Patent Application is being filed concurrently herewith or, if not being concurrently filed, was filed on January 8, 2014, and assigned Serial No. 14/150,337; and,

*WHEREAS*, Samsung Electronics Co., Ltd., a corporation duly organized under the laws of the Republic of Korea, located and doing business at 129, Samsung-ro, Yeongtong-gu, Suwon-si, Gyeonggi-do, Republic of Korea, 443-742 (hereinafter called "Assignee"), is desirous of acquiring the entire right, title and interest therein;

*NOW, THEREFORE, BE IT KNOWN* that for and in good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, Assignors do hereby sell, assign and transfer unto said Assignee the entire and exclusive worldwide right, title and interest in and to all said inventions and discoveries disclosed in said application, and in and to said application, any and all substitutions, divisions, provisionals, conversions of provisionals and continuations thereof, and in and to all Letters Patent, United States and foreign, that may be granted for said inventions and discoveries, and in and to all extensions, renewals and reissues thereof; and the right to file any foreign application and/or claim priority under the provisions of any international treaty or convention arising from this application or any divisional, continuing, substitute or reissue application therefrom. The aforesaid assignment includes the right in and to all income, royalties, damages and payments, now or hereafter due or payable with respect to any Letters Patent which may be granted, and in and to all causes of action (either in law or in equity); and the right to sue, counterclaim, and recover for past, present and future infringement of the rights assigned or to be assigned under this Assignment, as fully and entirely as the same would have been held and enjoyed by Assignors if this sale, assignment and transfer had not been made.

Assignors covenant and agree, without further compensation to said Assignors but at Assignee's expense:

- a. to execute:
  - i. all papers to be used in connection with this application and any divisional, continuing, substitute or reissue application thereof, as the Assignee may deem necessary or expedient, and

- ii. all papers in connection with any interference, litigation, mediation, arbitration or other proceeding relating to this application or any divisional, continuing, substitute or reissue application thereof, as may be necessary or expedient;
- b. to cooperate with the Assignee in every way possible in obtaining evidence and going forward in any interference, litigation, mediation, arbitration or other proceeding relating to said invention, said application and any divisional, continuing, substitute or reissue application thereof;
- c. to communicate to the Assignee any facts relating to said invention, said application and any divisional, continuing, substitute or reissue application thereof, including evidence for any interference, litigation, mediation, arbitration or other proceeding relating to said invention, whenever requested;
- d. to testify in any interference, litigation, mediation, arbitration or other proceeding relating to said invention, said application and any divisional, continuing, substitute or reissue application thereof whenever requested; and
- e. to perform all other affirmative acts which may be necessary or desirable to secure full and complete protection of the inventions and discoveries or that may be necessary or desirable to vest in Assignee the complete title to the inventions and discoveries and Letters Patent hereby conveyed and to enable Assignee to record title.


Assignors hereby authorize and request the United States Patent and Trademark Office or any other issuing authority to issue any and all Letters Patent that may be granted upon this invention and/or this application or any divisional, continuing, substitute or reissue application thereof to the Assignee, its legal representatives, successors and assigns.

Assignors each hereby represents, covenants and warrants that he or she has the full right to convey the entire right, title and interest by this instrument, free of any encumbrances and that no other agreement has been or will be executed in conflict herewith.

The provisions of this Assignment are binding upon Assignors' heirs, legal representatives and/or administrators and assigns.

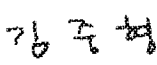
Assignors hereby grant to the law firm of Jefferson IP Law, LLP of Washington, DC and its attorneys and agents as associated with **Customer No. 68103** the authority and power to insert on this instrument any further identification which may be necessary or desirable for purposes of recordation in the United States Patent and Trademark Office or a Patent Office of any foreign country.

Signature of Inventor:

  
\_\_\_\_\_  
Ji-Hyun PARK

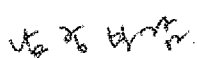
Feb. 13, 2014  
Date

Signature of Inventor:

  
\_\_\_\_\_  
Jung-Hyung KIM

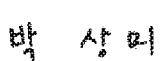
Feb. 13, 2014  
Date

Signature of Inventor:

  
\_\_\_\_\_  
Bo-Ram NAMGOONG


Feb. 13, 2014  
Date

Signature of Inventor:

  
\_\_\_\_\_  
Sang-Mi PARK

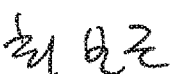
Feb. 13, 2014  
Date

Signature of Inventor:

  
\_\_\_\_\_  
Sung-Kwang YANG

Feb. 13, 2014  
Date

Signature of Inventor:

  
\_\_\_\_\_  
Bo-Kun CHOI

Feb. 13, 2014  
Date